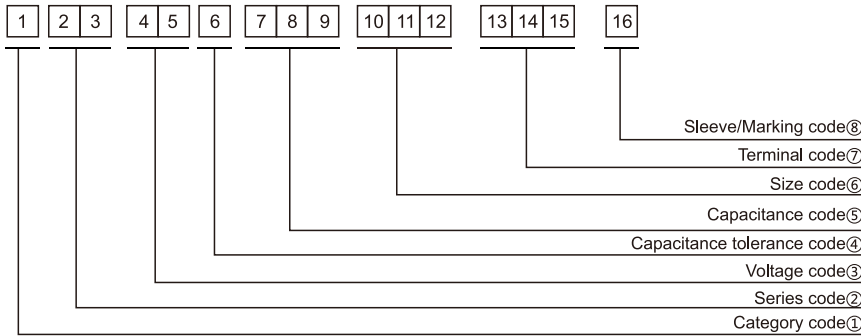


Part Numbering System



① Category code

Type	Code
	1
Electrolytic Capacitor	E
Conductive Polymer	S

② Series code

Series name	Code	
	2	3
WH	W	H
CD11GE	G	E
CD11GES	G	X
CD11GAS	G	W
CD11GHS	G	S
NR	N	R
PZ	P	Z

③ Voltage code

WV (V _{dc})	Code	
	4	5
2.5	0	E
3	0	D
4	0	G
6.3	0	J
6.8	0	C
7	0	Q
7.5	0	A
10	1	A
12	1	T
16	1	C
25	1	E
35	1	V
40	1	G
50	1	H
63	1	J
80	1	B
100	1	K
120	2	B
160	2	C
180	2	L
200	2	D
220	2	N
250	2	E
315	2	F
350	2	V
380	2	P
400	2	G
420	2	T
450	2	W
500	2	H
550	2	J
600	2	K

④ Capacitance tolerance code

Tol. (%)	Code
	6
-10~+10	K
-20~+20	M
-10~+30	Q
-10~+20	V
0~+20	A
-5~+20	C
-10~-20	B
-5~+5	D
0~+10	E
-5~-20	F
-15~+5	N

⑤ Capacitance code

Cap (μF)	Code		
	7	8	9
0.10	R	1	0
0.22	R	2	2
0.33	R	3	3
0.47	R	4	7
0.68	R	6	8
1	0	1	0
2.2	2	R	2
3.3	3	R	3
4.7	4	R	7
6.8	6	R	8
10	1	0	0
22	2	2	0
33	3	3	0
47	4	7	0
68	6	8	0
100	1	0	1
220	2	2	1
330	3	3	1
470	4	7	1
680	6	8	1
1000	1	0	2
2200	2	2	2
3300	3	3	2
4700	4	7	2
6800	6	8	2
10000	1	0	3
22000	2	2	3
33000	3	3	3
68000	6	8	3

⑥ Size code

ΦD (mm)	Code
10	
4	C
5	D
6.3	E
8	F
10	G
11	H
12	J
12.5	W
13	K
14	X
16	L
18	M
19	Z
20	N
22	O
25	P
30	Q
35	R
40	Y
51.6	S
64.3	T
76.9	U
91	V
100	A

L (mm)	Code	
	11	12
5	0	5
7	0	7
11	1	1
12	1	2
16	1	6
20	2	0
25	2	5
30	3	0
35	3	5
40	4	0
46	4	6
50	5	0
60	6	0
80	8	0
100	A	0
115	B	5
120	C	0
130	D	0
140	E	0
160	G	0
200	K	0
220	M	0
236	N	6
250	P	0

⑦ Terminal code

Specification	Code	Size	
	13	14	15
Bulk packing	O	-	-
Taping (SMD Type)	D	0	0
Φ4~8 Taping F=5.0mm	P	5	0
Φ10~12.5 Taping F=5.0mm	B	5	0
Lead Cut L=3.5mm	C	3	5
Lead Cut L=11.0mm	C	B	0
Lead Forming & Cut L=4.5mm	F	-	-
Kink & Cut L=4.5mm	J	-	-
Snap-in type Terminal 4.0mm in length	K	-	-
Three Terminals	T	-	-
Ring clip mounting standard design	A	0	0
Ring clip mounting special design	S	-	-

⑧ Sleeve/Marking code

Sleeve/Marking	Code
	16
PVC	C
PET	T
Dark blue	B
Bright red	R
Sky-blue	S
Light blue	T
Pink	Z
Black	H
Purple-blue	V
Red	O

Lead Forming
Taping Specifications

Fig.1 code: X



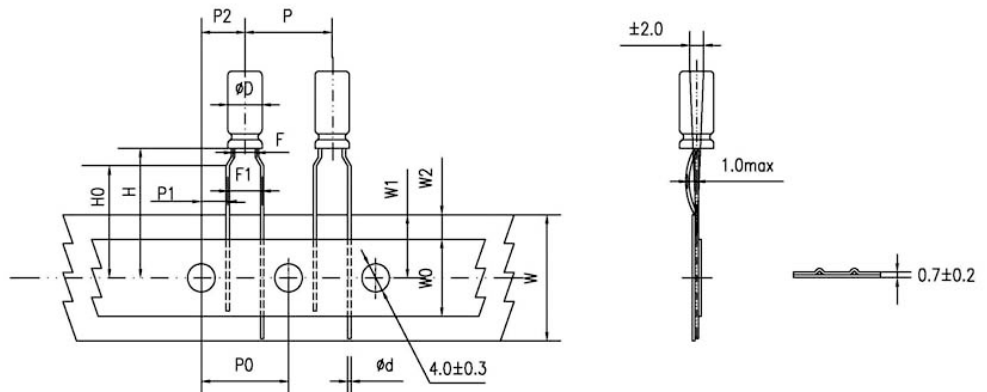
Fig.2 code: B



Fig.3 code: B



Fig.4 code: P



Lead Forming

Specification Fig.1 & Fig.2 & Fig.3

Items	Symbol	Case size										Tolerance		
		4*5 4*7		5*5 5*7		5*11		6.3*5	6.3*7 6.3*9	6.3*11 6.3*12	8*5/7 8*9/11 8*11.5 8*12		8*16 8*20	10*9/12 10*12.5 10*13/16 10*20/25
Pin Code		X	B	X	B	X	B	B	B	B	B	B	B	
Lead wire diameter	Φd	0.45		0.45		0.5		0.45	0.5	0.5	0.45/0.5	0.6	0.6	±0.05
Pitch of body	P	12.7		12.7		12.7		12.7	12.7	12.7	12.7	12.7	12.7	±1.0
Feed hole pitch	P0	12.7		12.7		12.7		12.7	12.7	12.7	12.7	12.7	12.7	±0.2
Distance from hole center to lead	P1	5.1	5.6	5.1	5.35	5.1	5.35	5.1	5.1	5.1	4.6	4.6	3.85	±0.7
Distance from feed hole center to body center	P2	6.35		6.35		6.35		6.35	6.35	6.35	6.35	6.35	6.35	±1.0
Lead-to-lead distance	F	2.5	1.5	2.5	2.0	2.5	2.0	2.5	2.5	2.5	3.5	3.5	5.0	±0.5
Height of body from tape center	H	18.5		18.5		18.5		18.5	18.5	18.5	18.5	18.5	18.5	±0.75
Base tape width	W	18.0		18.0		18.0		18.0	18.0	18.0	18.0	18.0	18.0	±0.5
Adhesive tape width	W0	6.0		6.0		6.0		6.0	6.0	8.0	8.0	8.0	11.0	min
Hole position	W1	9.0		9.0		9.0		9.0	9.0	9.0	9.0	9.0	9.0	+0.75 -0.5
Hole down tape position	W2	3.0		3.0		3.0		3.0	3.0	3.0	3.0	3.0	3.0	max

Specification Fig.4

Items	Symbol	Case size									Tolerance
		4*5 4*7	5*5	5*7	5*11	6.3*5	6.3*7 6.3*9	6.3*11 6.3*12	8*5/7 8*9/11 8*11.5/12	8*16 8*20	
Pin Code		P	P	P	P	P	P	P	P	P	
Lead wire diameter	Φd	0.45	0.45	0.45	0.5	0.45	0.5	0.5	0.45/0.5	0.6	±0.05
Pitch of body	P	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	±1.0
Feed hole pitch	P0	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	12.7	±0.2
Distance from hole center to lead	P1	3.85	3.85	3.85	3.85	3.85	3.85	3.85	3.85	3.85	±0.7
Distance from feed hole center to body center	P2	6.35	6.35	6.35	6.35	6.35	6.35	6.35	6.35	6.35	±1.0
Lead-to-lead distance	F	1.5	2.0	2.0	2.0	2.5	2.5	2.5	3.5	3.5	±0.5
Lead to lead distance	F1	5.0	5.0	5.0	5.0	5.0	5.0	5.0	5.0	5.0	+0.8 -0.2
Height of body from tape center	H	18.5	18.5	18.5	18.5	18.5	18.5	18.5	18.5	18.5	±0.75
Lead wire clinch height	H0	16.0	16.0	16.0	16.0	16.0	16.0	16.0	16.0	16.0	±0.5
Base tape width	W	18.0	18.0	18.0	18.0	18.0	18.0	18.0	18.0	18.0	±0.5
Adhesive tape width	W0	6.0	6.0	6.0	6.0	6.0	6.0	8.0	8.0	8.0	min
Hole position	W1	9.0	9.0	9.0	9.0	9.0	9.0	9.0	9.0	9.0	+0.75 -0.5
Hole down tape position	W2	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	max

Lead Forming

Lead Forming & Cut

Code:C
RANGE: $\Phi 4\sim\Phi 18$



Code:F
RANGE: $\Phi 4\sim\Phi 8$



ΦD	F	L	ΦD	F	L
4	1.5	3.0~12.0	4	5.0	3.5, 4.5, 5.0, 7.0
5	2.0	3.0~12.0	5	5.0	3.5, 4.5, 5.0, 7.0
6.3	2.5	3.0~12.0	6.3	5.0	3.5, 4.5, 5.0, 7.0
8	3.5	3.0~12.0	8	5.0	3.5, 4.5, 5.0, 7.0
10	5.0	3.0~12.0	-	-	-
12.5	5.0	3.0~12.0	-	-	-
16	7.5	3.0~12.0	-	-	-
18	7.5	3.0~12.0	-	-	-

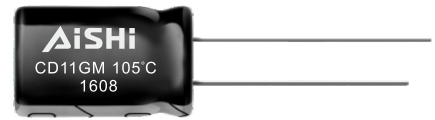
Code:J
RANGE: $\Phi 10\sim\Phi 18$



ΦD	F	L
10	5.0	4.0, 4.5, 5.0
12.5	5.0	4.0, 4.5, 5.0
16	7.5	4.0, 4.5, 5.0
18	7.5	4.0, 4.5, 5.0

CD11GM series

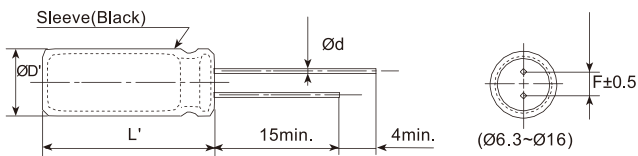
- Endurance: +105°C 3,000 hours
- Economical type, miniaturized
- RoHS Compliant



SPECIFICATIONS

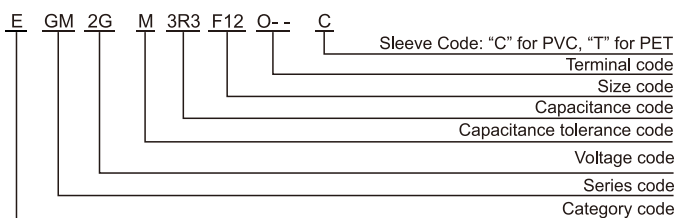
Items	Characteristics					
Category Temperature Range	-40~+105°C (160~400 V _{dc})					
Rated Voltage Range	160~400 V _{dc}					
Capacitance Tolerance	±20%(M) (at 20°C, 120Hz)					
Leakage Current	I ≤ 0.02CV + 25μA (160~400 V _{dc}) Where, I: Max. leakage current (μA), C: Nominal capacitance (μF), V: Rated voltage (V) (at 20°C after 2 minutes)					
Dissipation Factor (tanδ)	Rated Voltage(V _{dc})	160	200	250	400	(at 20°C, 120Hz)
	tanδ (max.)	0.15	0.15	0.15	0.20	
Low Temperature Characteristics (Max. Impedance Ratio)	Rated Voltage(V _{dc})	160	200	250	400	(at 120Hz)
	Z(-25°C)/Z(+20°C)	3	3	3	5	
	Z(-40°C)/Z(+20°C)	6	6	6	6	
Endurance	The specifications listed below shall be met when the capacitors are restored to 20°C after DC voltage plus rated ripple current is applied for 3,000 hours at 105°C, the peak voltage shall not exceed the rated voltage.					
	Capacitance Change	≤±20% of the initial value				
	D.F. (tanδ)	≤200% of the initial specified value				
	Leakage Current	≤The initial specified value				
Shelf Life	The following specifications shall be satisfied when the capacitors are restored to 20°C after leaving them under no load at 105°C for 1,000 hours.					
	Capacitance Change	≤±20% of the initial value				
	D.F. (tanδ)	≤200% of the initial specified value				
	Leakage Current	≤500% of the initial specified value				

DIMENSIONS [mm]



ØD	6.3	8	10	12.5	13	16
Ød	0.5	0.5	0.6	0.6	0.6	0.8
F	2.5	3.5	5.0	5.0	5.0	7.5
ØD'	ØD+0.5max.					
L'	L+2max.					

PART NUMBERING SYSTEM



RATED RIPPLE CURRENT MULTIPLIERS

Frequency correction factor for ripple current

Rated voltage(V _{dc})	Freq.(Hz)			
160~400	120	1k	10k	100k
	0.50	0.80	0.90	1.00

CD11GM series

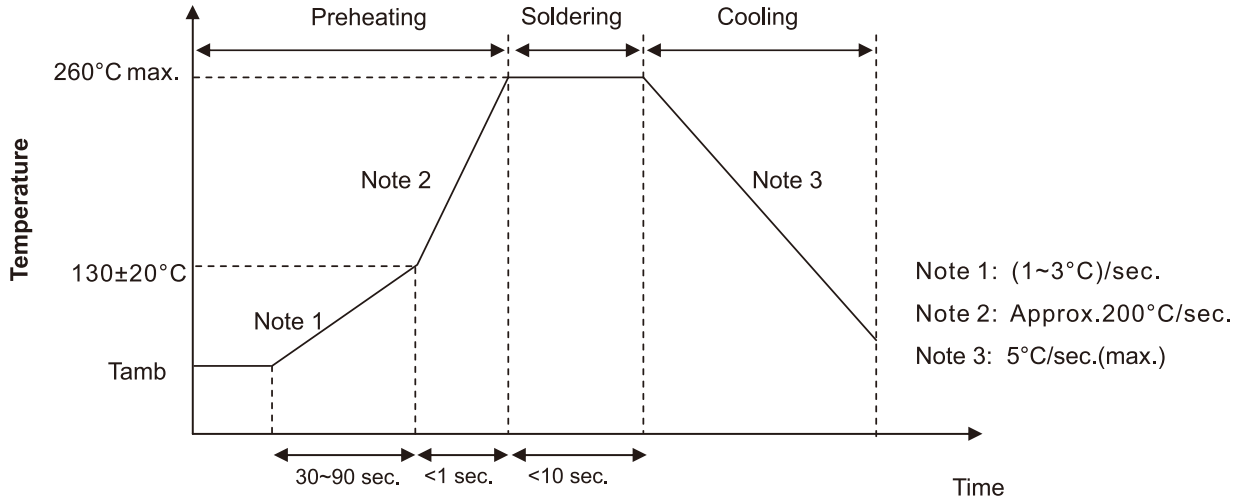
■ STANDARD RATINGS

WV (V _{dc})	Cap (μF)	Size ΦDxL (mm)	tanδ	Rated ripple current (mA _{rms} /105°C, 100kHz)
160(2C)	4.7	6.3*7	0.15	52
	5.6	6.3*9	0.15	58
	6.8	6.3*12	0.15	70
	8.2	6.3*12	0.15	100
			0.15	135
			0.15	135
	10	8*9	0.15	135
			0.15	145
			0.15	162
	15	8*12	0.15	180
			0.15	160
			0.15	245
	22	8*16	0.15	260
			0.15	320
33	10*16	0.15	365	
		0.15	400	
47	10*20	0.15	450	
		0.15	490	
56	12.5*16	0.15	490	
		0.15	530	
200(2D)	4.7	6.3*9	0.15	52
	5.6	6.3*12	0.15	62
	6.8	6.3*12	0.15	76
	8.2	8*9	0.15	90
			0.15	95
	10	8*12	0.15	130
			0.15	145
			0.15	145
	15	8*12	0.15	170
			0.15	185
	22	8*16	0.15	255
	33	10*16	0.15	330
	47	10*20	0.15	420
	56	12.5*20	0.15	500

WV (V _{dc})	Cap (μF)	Size ΦDxL (mm)	tanδ	Rated ripple current (mA _{rms} /105°C, 100kHz)
250(2E)	4.7	6.3*9	0.15	80
		6.3*12	0.15	85
		8*9	0.15	80
		8*12	0.15	90
	6.8	8*9	0.15	92
			0.15	96
			0.15	96
	8.2	8*12	0.15	100
			0.15	100
			0.15	150
	10	10*9	0.15	150
			0.15	195
	15	8*16	0.15	280
			0.15	360
22	10*16	0.15	360	
		0.15	430	
33	10*20	0.15	430	
		0.15	455	
400(2G)	1	6.3*9	0.20	35
	1.5	6.3*9	0.20	40
	1.8	6.3*12	0.20	49
	2.2	6.3*12	0.20	60
			0.20	60
	3.3	8*9	0.20	70
			0.20	75
	4.7	8*12	0.20	95
			0.20	95
	6.8	8*12	0.20	117
			0.20	130
			0.20	130
	10	8*16	0.20	170
			0.20	170
0.20			195	
15	10*16	0.20	230	
22	12.5*20	0.20	345	
33	13*20	0.20	445	
47	16*25	0.20	650	

Solering Recommendation

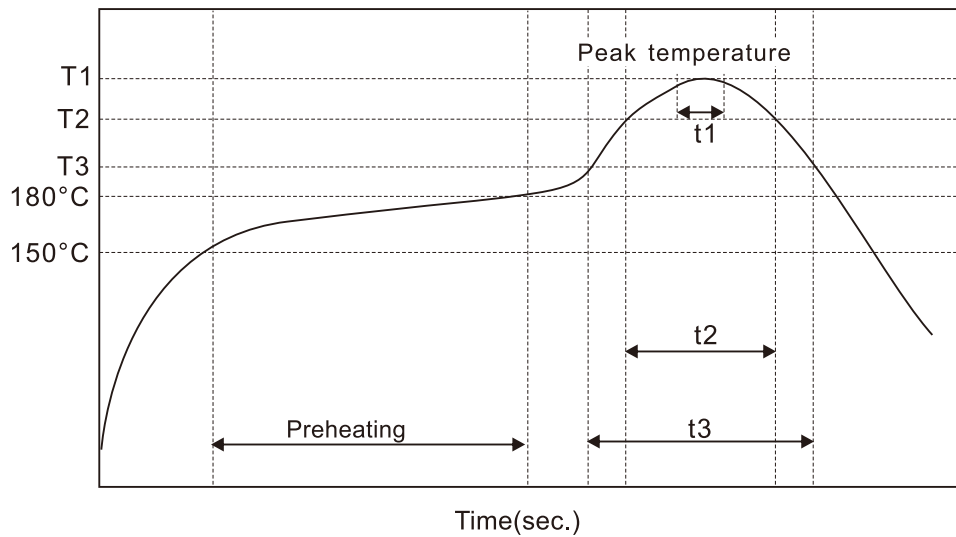
■ Flow Soldering(Radial Lead Type)



■ Reflow Soldering

- (For Polymer SMD Type)

Recommended Reflow Profile

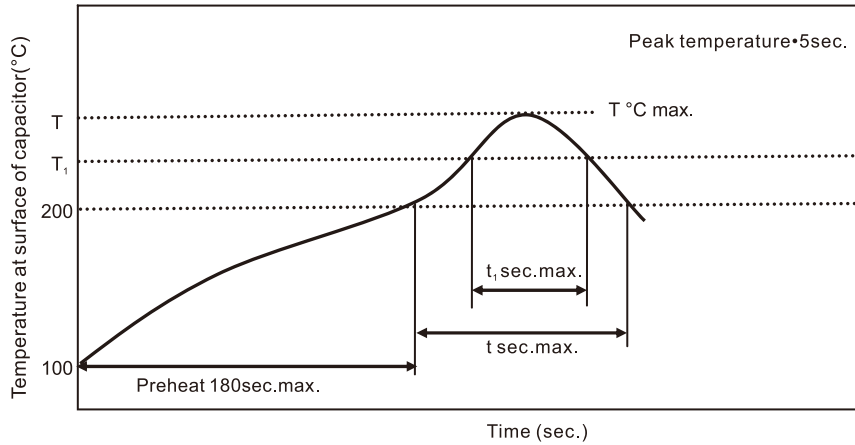


Item	Preheating	T1(°C)	T2(°C)	T3(°C)	t1(sec.)	t2(sec.)	t3(sec.)	Reflow cycle
Condition 1	150°C to 180°C Within 90sec.	≤260	230	200	≤10	≤40	≤60	1
Condition 2		≤250	230	200	≤10	≤40	≤60	2

● (For Liquid SMD Type)

Case size: $\Phi 6.3$ – $\Phi 10$ mm:

- Temperature at surface of capacitor shall not exceed $T^{\circ}\text{C}$.
- The duration for over 200°C temperature and $T_1^{\circ}\text{C}$ at surface of capacitor shall not exceed t and t_1 seconds, respectively.
- Preheat shall be done at 100°C to 200°C and for Maximum 180 seconds.

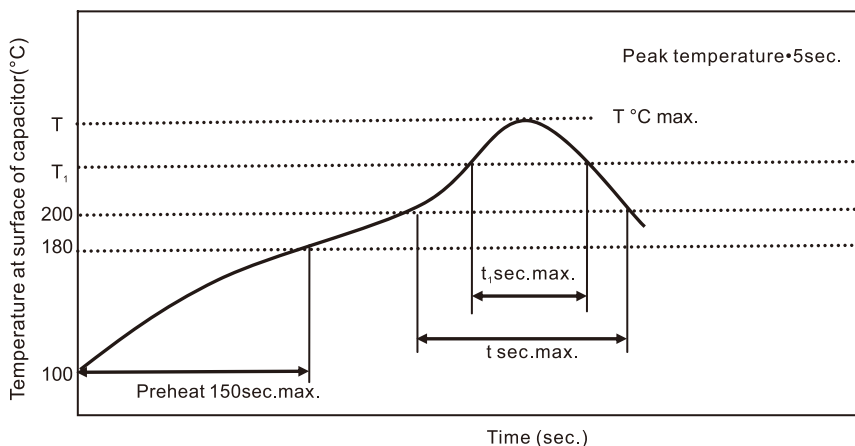


Case size (mm)	$T(^{\circ}\text{C})$ ①	$T_1(^{\circ}\text{C})$	$t(\text{sec.})$ ②	$t_1(\text{sec.})$ ③	Reflow cycle
$\Phi 6.3$	250	230	90	40	1
$\Phi 8$	240	230	90	30	1
$\Phi 10$	235	230	60	30	1

- ① Peak temperature
- ② The duration over 200°C (max.)
- ③ The duration over $T_1^{\circ}\text{C}$
- Please contact us if capacitors are subject to the conditions other than the allowable range of reflow.

Case size: $\Phi 12.5$ – $\Phi 18$ mm:

- Temperature at surface of capacitor shall not exceed $T^{\circ}\text{C}$.
- The duration for over 200°C temperature and $T_1^{\circ}\text{C}$ at surface of capacitor shall not exceed t and t_1 seconds, respectively.
- Preheat shall be done at 100°C to 180°C and for Maximum 150 seconds.



Case size (mm)	$T(^{\circ}\text{C})$ ①	$T_1(^{\circ}\text{C})$	$t(\text{sec.})$ ②	$t_1(\text{sec.})$ ③	Reflow cycle
$\Phi 12.5$ – $\Phi 18$	240	230	60	30	1

- ① Peak temperature
- ② The duration over 200°C (max.)
- ③ The duration over $T_1^{\circ}\text{C}$
- Please contact us if capacitors are subject to the conditions other than the allowable range of reflow.